

6. (Amended) A carrier bag for an electronic component, which is made of the heat-sealing film as defined in Claim 1.

11. (Amended) The process for producing the heat-sealing film according to Claim 9, wherein corona discharge treatment is applied to at least the surface to be treated by antistatic treatment, prior to the step of applying antistatic treatment.

12. (Amended) The process according to Claim 7, wherein all steps are carried out within one and the same line.

Please add the following new claims:

13. (New) The process for producing the heat-sealing film according to Claim 10, wherein corona discharge treatment is applied to at least the surface to be treated by antistatic treatment, prior to the step of applying antistatic treatment.

14. (New) The process according to Claim 8, wherein all steps are carried out within one and the same line.

15. (New) The process according to Claim 9, wherein all steps are carried out within one and the same line.

16. (New) The process according to Claim 10, wherein all steps are carried out within one and the same line.

17. (New) The process according to Claim 11, wherein all steps are carried out within one and the same line.

18. (New) The process according to Claim 13, wherein all steps are carried out within one and the same line.